
M16C/63, 64, 64A, 64C, 65, 65C, 6C, 5L, 56, 5LD, 56D,
5M, and 57 Groups

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Tolerance of Data Transfer Rate in Clock Asynchronous Serial I/O Mode

Abstract

This document describes tolerance of data transfer rate in clock asynchronous serial I/O mode for the M16C/63, 64, 64A, 64C, 65, 65C, 6C, 5L, 56, 5LD, 56D, 5M, and 57 Groups. "i" in UARTi refers to a channel number. The number of channels varies according to the MCU used. Refer to the User's Manual: Hardware for details.

Products

M16C/63, 64, 64A, 64C, 65, 65C, 6C, 5L, 56, 5LD, 56D, 5M, and 57 Groups

When using this application note with other Renesas MCUs, careful evaluation is recommended after making modifications to comply with the alternate MCU.

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1. Specifications

1.1 Data Format

This section describes the data format in clock asynchronous serial I/O mode. Table 1.1 lists the Transmit/Receive Data Types and Their Functions. Figure 1.1 shows the Data Format Pattern.

Table 1.1 Transmit/Receive Data Types and Their Functions

Transmit/Receive Data Type	Function	Remarks
ST (start bit)	Low signal which is 1 bit of the character bit, and added immediately before the character bit. This bit indicates the start of data.	1 bit
DATA (character bit)	Transmit data set in the UARTi transmit buffer register.	Selectable from 7 bits, 8 bits, and 9 bits
P (parity bit)	A signal added immediately after the character bit to improve reliability of data. The signal level is changed according to whether the selection for the parity is even or odd. The total number of 1's for this bit and the character bit always becomes even or odd according to even or odd parity.	Selectable from odd, even, and none
SP (stop bit)	High signal which is 1 bit or 2 bits of the character bit, and added immediately after the character bit (parity bit when the parity is enabled). This bit indicates that data transfer is complete.	Selectable from 1 bit and 2 bits.

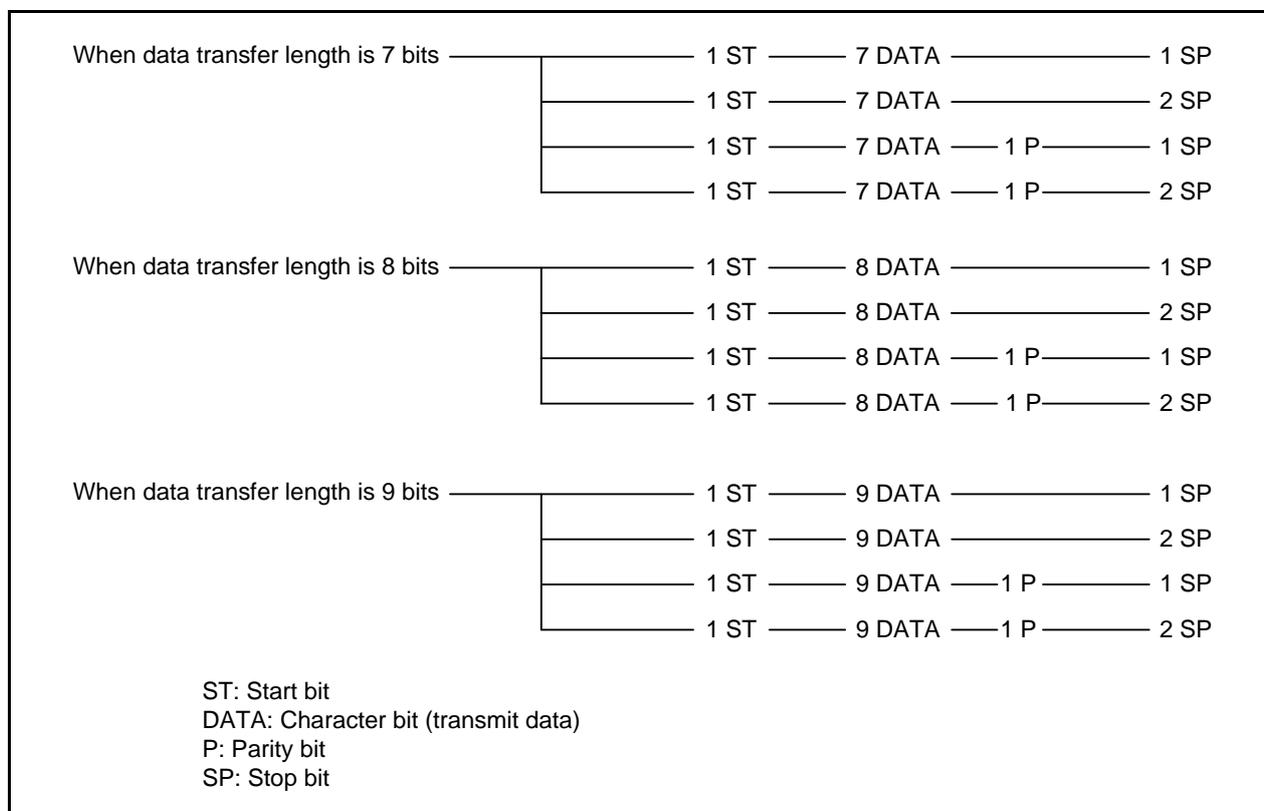


Figure 1.1 Data Format Pattern

1.2 Relation between Receiver Clock and Received Data

During reception, received data that is input to the RXDi pin is obtained at the rising edge of the receiver clock. Therefore, to receive data correctly, the stop bit must be input at the last rising edge of the receiver clock for 1 frame of data (i.e. the data from the start bit to the stop bit).

Figure 1.2 shows the Relation between Receiver Clock and Received Data.

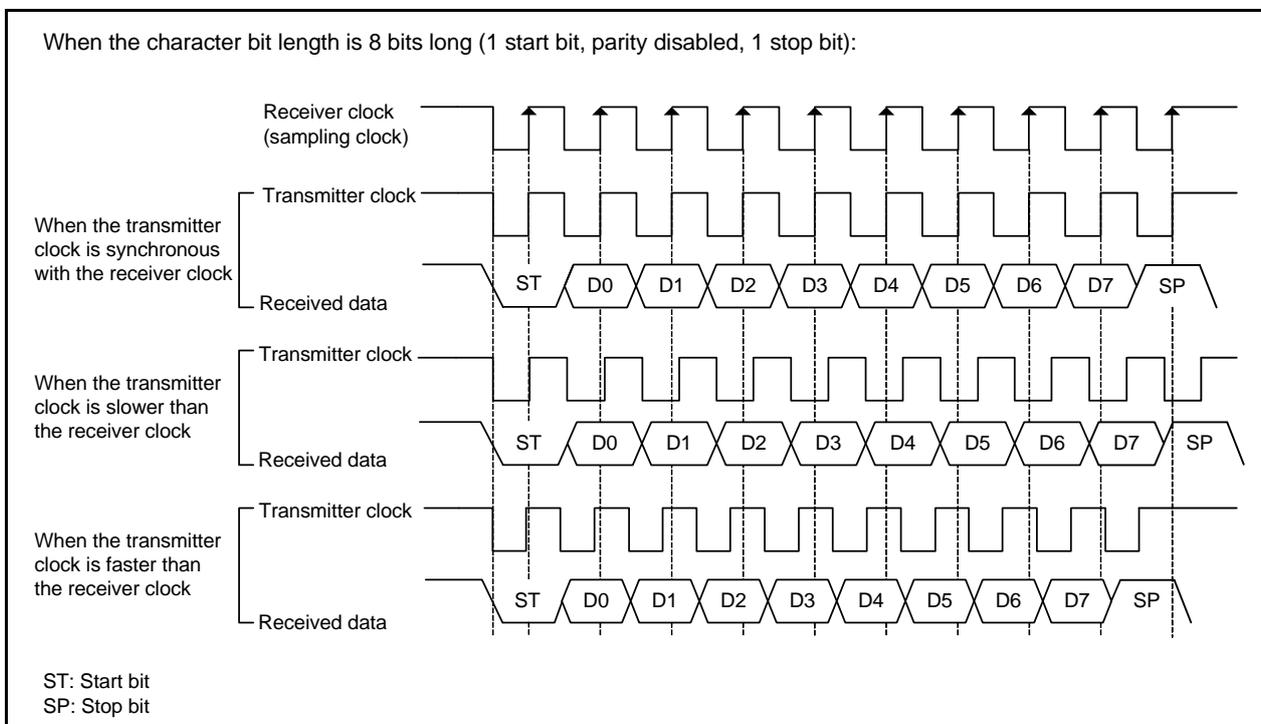


Figure 1.2 Relation between Receiver Clock and Received Data

1.3 Calculating Tolerance of Data Transfer Rate

To transmit and receive data correctly, data transfer rates of the transmitter and receiver must meet the relational expression below. Make sure the relational expression is satisfied, and the value is set with an adequate margin. Perform careful evaluation with the user application.

$$\left(\frac{1}{B_t} \times (b - 1) + \frac{(U_iBRG + 1)}{F} \right) < \left(\frac{1}{B_r} \times (b - 0.5) + \frac{(U_iBRG + 1)}{F} \right) < \left(\frac{1}{B_t} \times b \right)$$

- Bt: Data transfer rate of the transmitter in bps
- Br: Data transfer rate of the receiver in bps
- F: Frequency of the UiBRG count source in the receiver in Hz
- b: Total number of bits in 1 frame of data (however, subtract 1 from the value when using 2 stop bits)
- UiBRG: UiBRG register setting value

Figure 1.3 shows the Relations between Formulas and Operations.

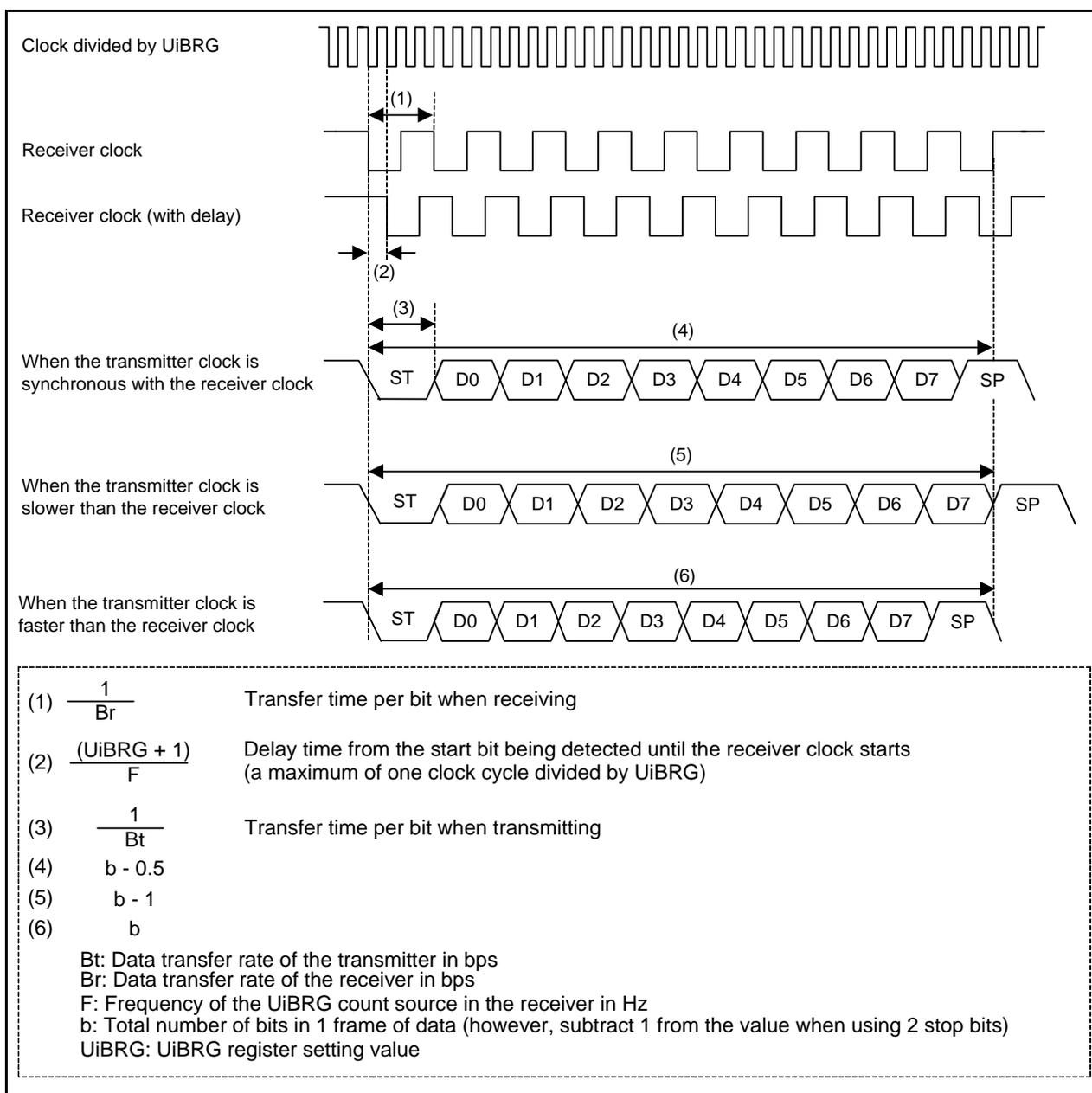


Figure 1.3 Relations between Formulas and Operations

1.3.1 Calculating the Receiver Clock Tolerance

This section describes an example of calculating the tolerance of data transfer rate for the receiver clock with the following conditions: 1 frame of data consists of the start bit, an 8-bit character length, and the stop bit, and the data transfer rate of the transmitter clock is 9600 bps.

Figure 1.4 shows the Calculating the Receiver Clock Tolerance.

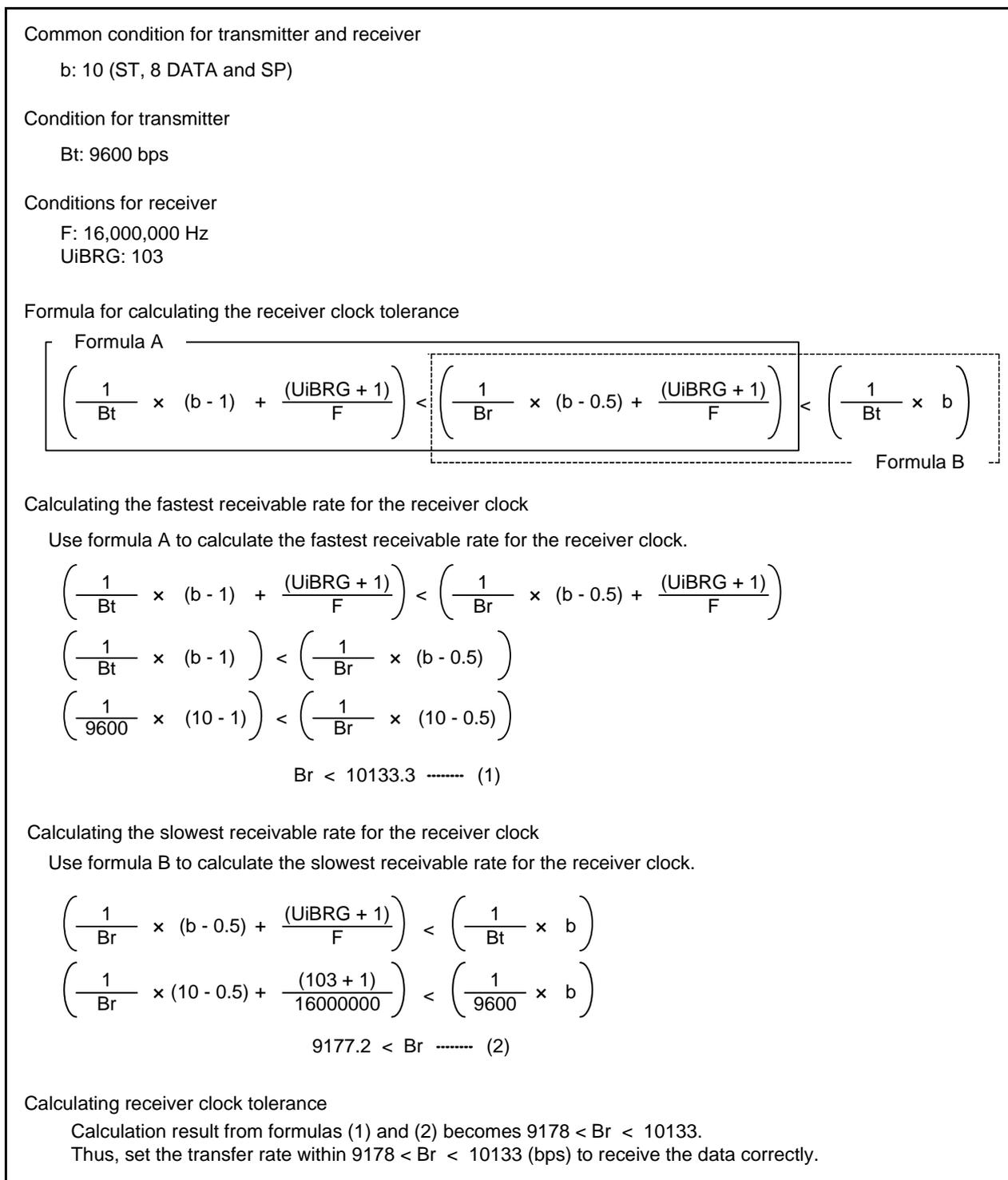


Figure 1.4 Calculating the Receiver Clock Tolerance

1.3.2 Calculating Tolerance of Data Transfer Rate

This section describes how to calculate tolerance of data transfer rate with or without delay time consideration.

Figure 1.5 shows the Tolerance Without Delay Time Consideration.

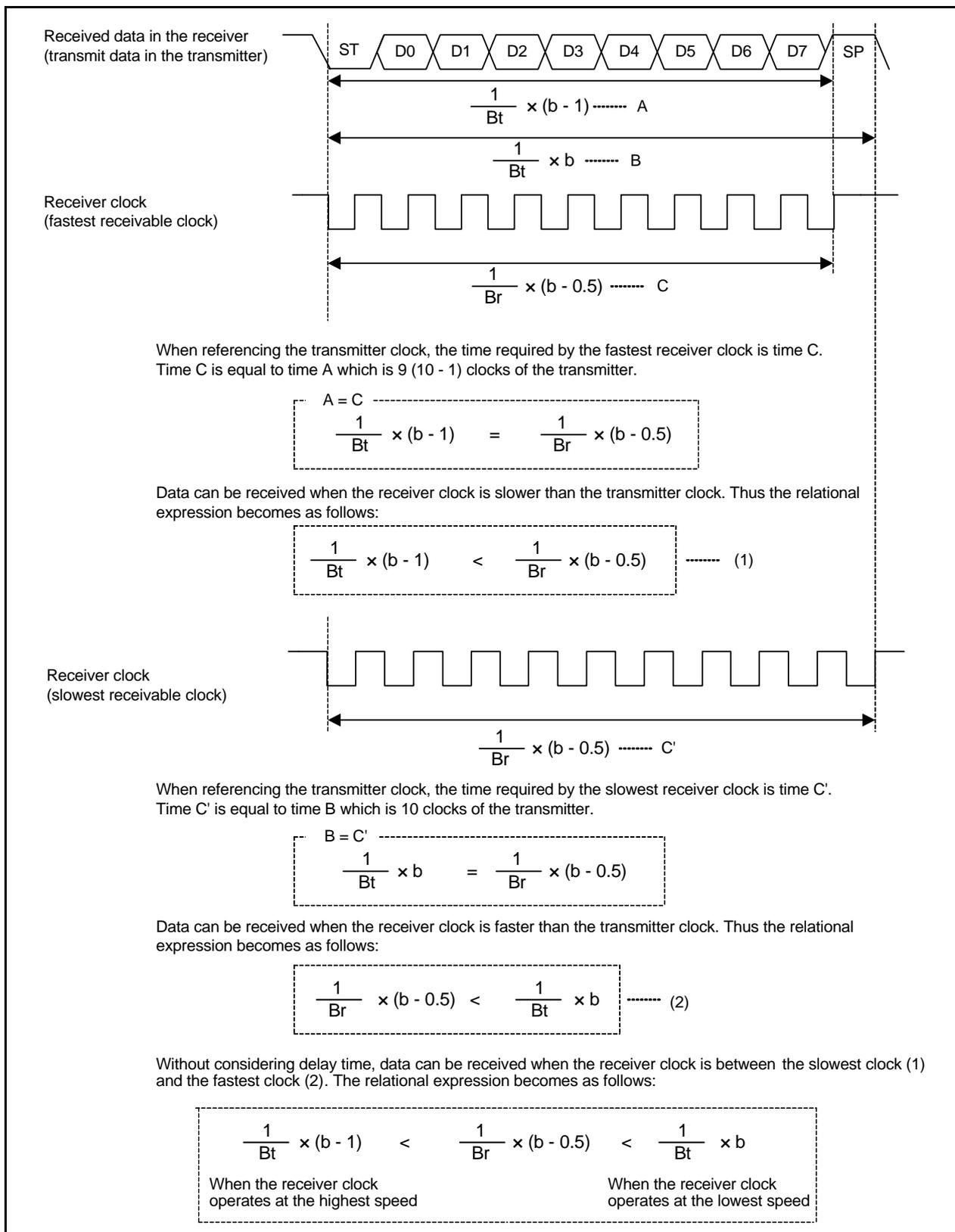


Figure 1.5 Tolerance Without Delay Time Consideration

Although the tolerance without considering delay time is shown in Figure 1.5, actually there is a delay of up to one cycle of the clock divided by UiBRG. Therefore, the transfer rate must be set while taking delay time into consideration.

Figure 1.6 shows the Fastest Receiver Clock with Delay Time Consideration, and Figure 1.7 shows Slowest Receiver Clock with Delay Time Consideration.

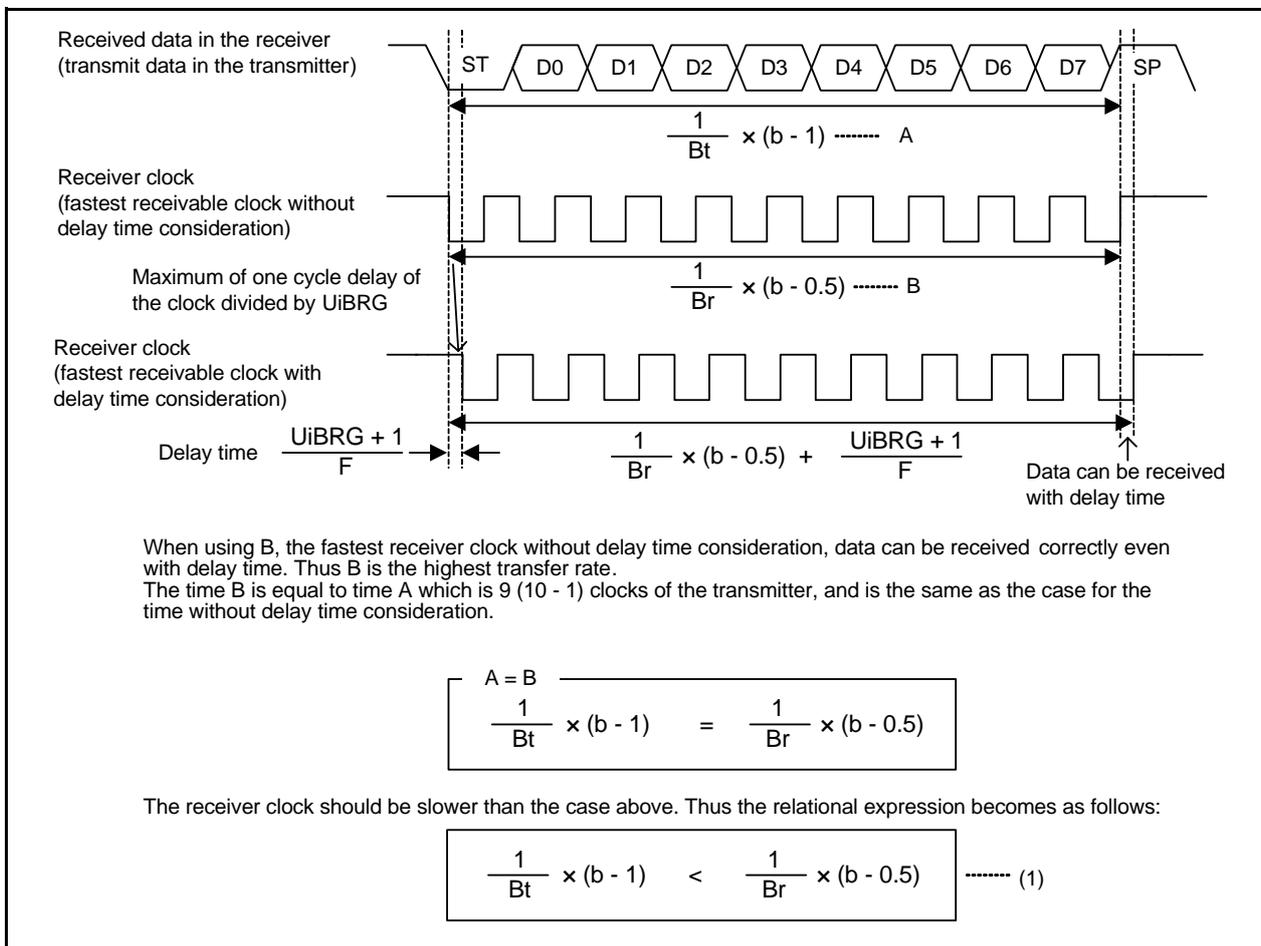


Figure 1.6 Fastest Receiver Clock with Delay Time Consideration

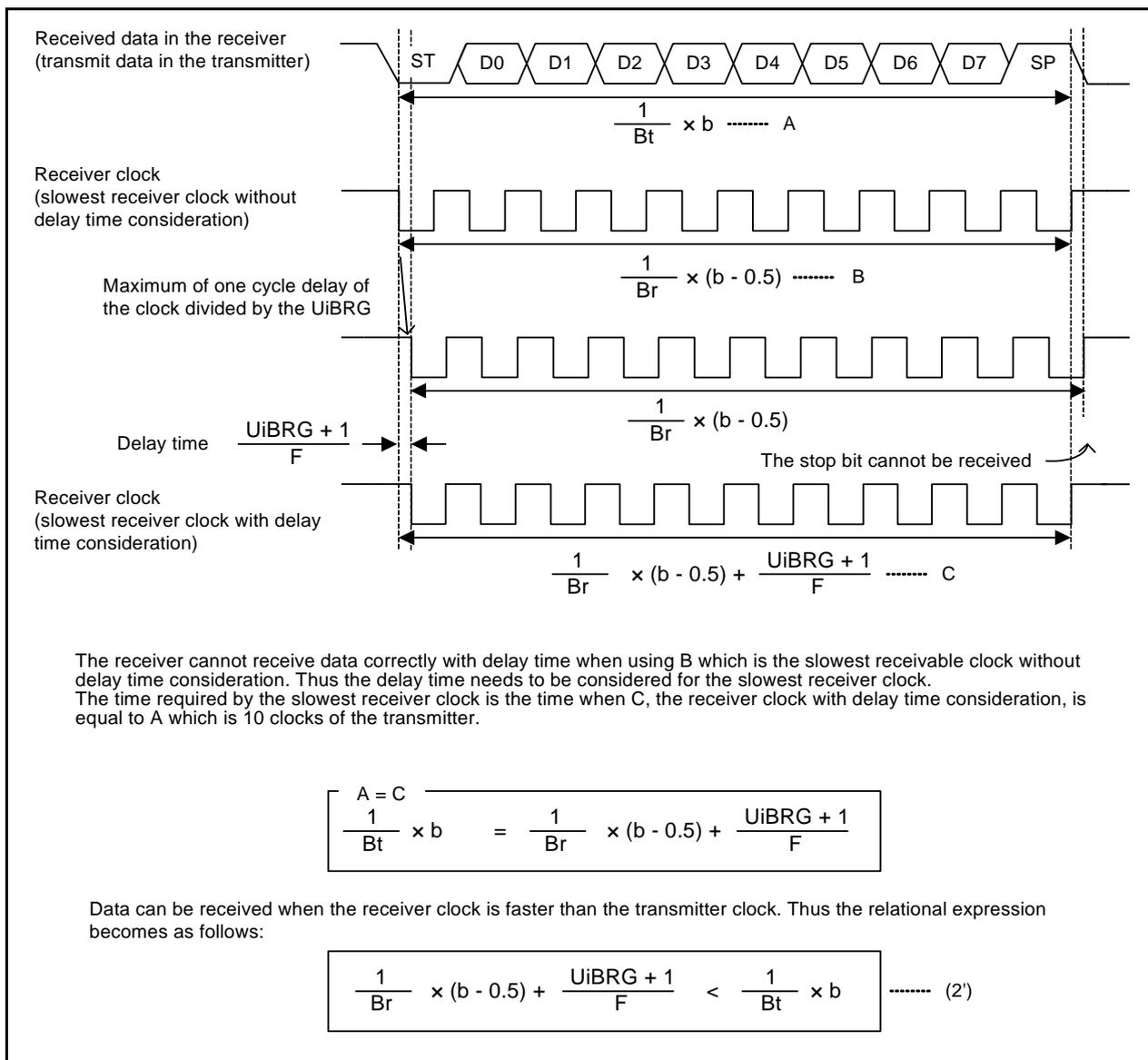


Figure 1.7 Slowest Receiver Clock with Delay Time Consideration

With delay time consideration, formula (1) in Figure 1.6 and formula (2') in Figure 1.7 produce the following formulas.

$$\frac{1}{B_r} \times (b - 0.5) + \frac{U_iBRG + 1}{F} < \frac{1}{B_t} \times b \dots\dots\dots (2')$$

$$\frac{1}{B_t} \times (b - 1) < \frac{1}{B_r} \times (b - 0.5) \dots\dots\dots (1)$$

To merge formulas (2') and (1), add $\frac{U_iBRG + 1}{F}$ to both sides of formula (1).

$$\frac{1}{B_t} \times (b - 1) + \frac{U_iBRG + 1}{F} < \frac{1}{B_r} \times (b - 0.5) + \frac{U_iBRG + 1}{F} \dots\dots\dots (1')$$

From formulas (2') and (1):

$\frac{1}{B_t} \times (b - 1) + \frac{U_iBRG + 1}{F} < \frac{1}{B_r} \times (b - 0.5) + \frac{U_iBRG + 1}{F} < \frac{1}{B_t} \times b$	
When the receiver clock operates at the highest speed	When the receiver clock operates at the lowest speed

When the above formula is satisfied, data can be received correctly.

Figure 1.8 Formulas for Tolerance of Data Transfer Rate

2. Reference Documents

M16C/63 Group User's Manual: Hardware Rev. 2.00
M16C/64 Group Hardware Manual Rev. 1.05
M16C/64A Group User's Manual: Hardware Rev. 2.00
M16C/64C Group User's Manual: Hardware Rev. 1.00
M16C/65 Group User's Manual: Hardware Rev. 2.00
M16C/65C Group User's Manual: Hardware Rev. 1.00
M16C/6C Group User's Manual: Hardware Rev. 2.00
M16C/5L Group, M16C/56 Group User's Manual: Hardware Rev. 1.10
M16C/5LD Group, M16C/56D Group User's Manual: Hardware Rev. 1.10
M16C/5M Group, M16C/57 Group User's Manual: Hardware Rev. 1.10
The latest versions can be downloaded from the Renesas Electronics website.

Technical Update/Technical News

The latest information can be downloaded from the Renesas Electronics website.

C Compiler Manual

M16C Series/R8C Series C Compiler Package V.5.45

C Compiler User's Manual Rev. 2.00

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Revision History	M16C/63, 64, 64A, 64C, 65, 65C, 6C, 5L, 56, 5LD, 56D, 5M, and 57 Groups Tolerance of Data Transfer Rate in Clock Asynchronous Serial I/O Mode
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Rev.	Date	Description	
		Page	Summary
1.00	Nov. 30, 2011	—	First edition issued

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General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to one with a different part number, confirm that the change will not lead to problems.

- The characteristics of MPU/MCU in the same group but having different part numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different part numbers, implement a system-evaluation test for each of the products.

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